GSMDS0956

100V N-Channel MOSFETs

Product Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are well suited for high efficiency fast switching applications.

Features

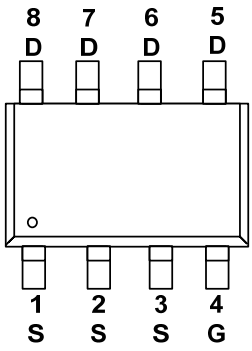
- 100V, 12A, $R_{DS(ON)}$=115mΩ@V_{GS}=10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available
- SOP-8 package design

Applications

- Networking
- Load Switch
- LED Applications

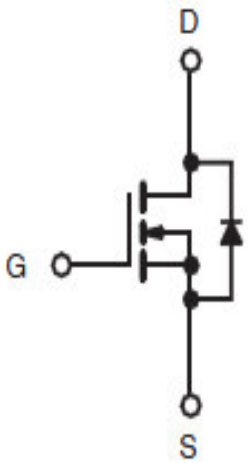
Packages & Pin Assignments

GSMDS0956SF (SOP-8)

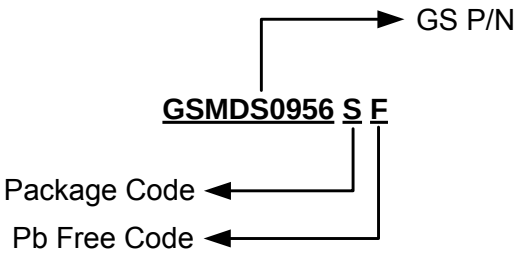


Top View

Pin	Description
1	Source
2	Source
3	Source
4	Gate
5	Drain
6	Drain
7	Drain
8	Drain

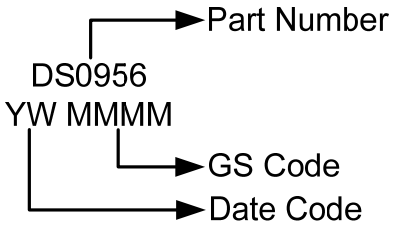


Ordering Information



Part Number	Package	Quantity Reel
GSMDS0956SF	SOP-8	4000 PCS

Marking Information



Absolute Maximum Ratings

T_A=25ºC Unless otherwise noted

Symbol	Parameter		Typical	Unit
V_{DS}	Drain-Source Voltage		100	V
V_{GS}	Gate-Source Voltage		±20	V
I_D	Continuous Drain Current	T_A=25℃	12	A
		T_A=100℃	7.6	
I_{DM}	Pulsed Drain Current		48	A
P_D	Power Dissipation (T_A=25℃)		3.6	W
	Power Dissipation (Derate above 25℃)		0.029	W/℃
T_J	Operating Junction Temperature Range		-55 to +150	℃
T_{STG}	Storage Temperature Range		-55 to +150	℃
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient		35	℃/W

Note 1: Repetitive Rating : Pulsed width limited by maximum junction temperature.
Note 2: V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=11A, R_G=25Ω, Starting T_J=25℃.

Electrical Characteristics

T_A=25℃ Unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}=0V,I_D=250uA	100			V
$\triangle BV_{DSS}/\triangle T_J$	BV_{DSS} Temperature Coefficient	Reference to 25℃, I_D=1mA		0.09		V/℃
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS},I_D=250uA	1.2	1.6	2.5	V
$\triangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient			-5		mV/℃
I_{GSS}	Gate Leakage Current	V_{DS}=0V,V_{GS}=±20V			±100	nA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=100V,V_{GS}=0V			1	uA
		V_{DS}=80V,V_{GS}=0V, T_J=125℃			10	
I_S	Continuous Source Current	V_G=V_D=0V, Force Current			12	A
I_{SM}	Pulsed Source Current				24	
$R_{DS(on)}$	Drain-Source On-Resistance	V_{GS} =10V,I_D=10A		90	115	mΩ
		V_{GS} =4.5V,I_D=8A		95	120	
g_{FS}	Forward Transconductance	V_{DS}=10V,I_D=2A		8.7		S
V_{SD}	Diode Forward Voltage	V_{GS}=0V,I_S=1A			1	V
t_{rr}	Reverse Recovery Time	V_{GS}=0V,I_S=1A, di/dt=100A/us		38		ns
Q_{rr}	Reverse Recovery Charge			27		nC
Dynamic						
Q_g	Total Gate Charge	V_{DS}=50V,V_{GS}=10V, I_D=2A		20	40	nC
Q_{gs}	Gate-Source Charge			3.2	6	
Q_{gd}	Gate-Drain Charge			3.6	7	
C_{iss}	Input Capacitance	V_{DS}=25V,V_{GS}=0V, f=1MHz		1400	2800	pF
C_{oss}	Output Capacitance			60	120	
C_{rss}	Reverse Transfer Capacitance			35	70	
$t_{d(on)}$	Turn-On Time	V_{DD}=50V,I_D=1A, V_{GS}=10V,R_G=3.3Ω		18	36	ns
t_r				4	8	
$t_{d(off)}$	Turn-Off Time			40	80	
t_f				3	6	
R_g	Gate Resistance	V_{DS}=0V,V_{GS}=0V, f=1MHz		2	4	Ω

Note 3: The data tested by pulsed, pulse width≦300us, duty cycle≦2%.

Note 4: Essentially independent of operating temperature.

Typical Performance Characteristics

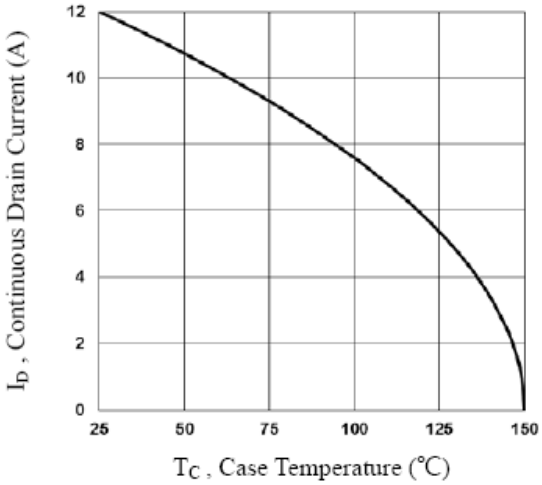


Fig.1 Continuous Drain Current vs. T_c

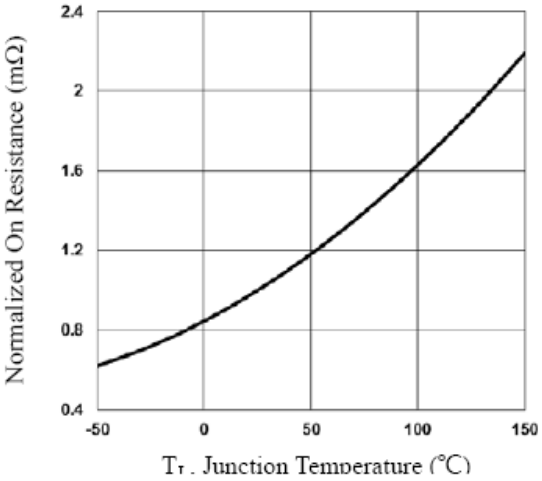


Fig.2 Normalized RDSON vs. T_J

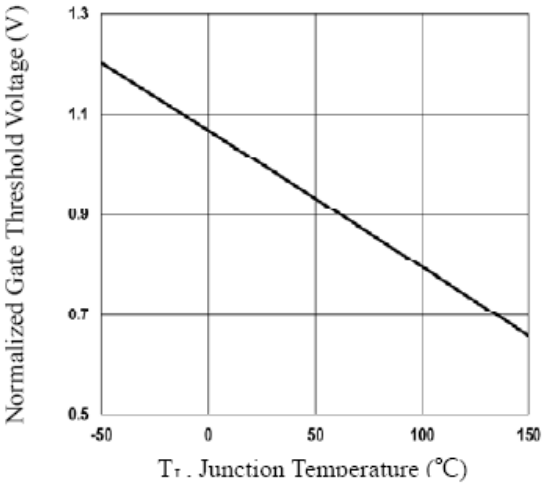


Fig.3 Normalized V_{th} vs. T_J

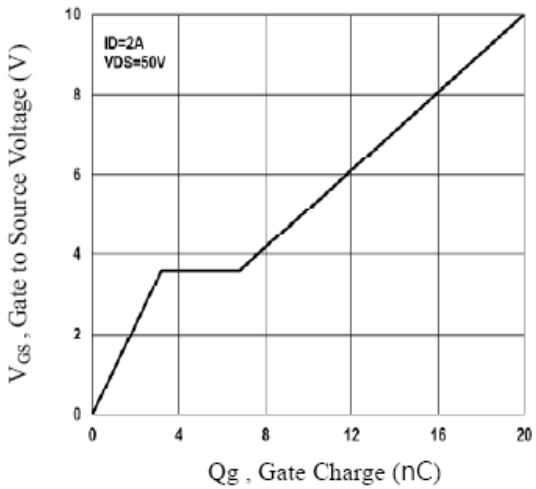


Fig.4 Gate Charge Waveform

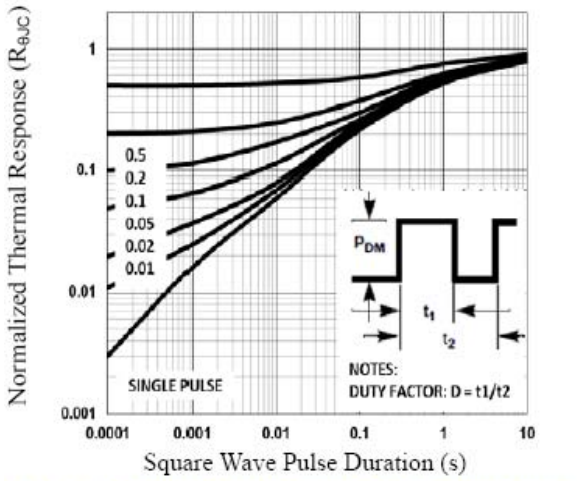


Fig.5 Normalized Transient Impedance

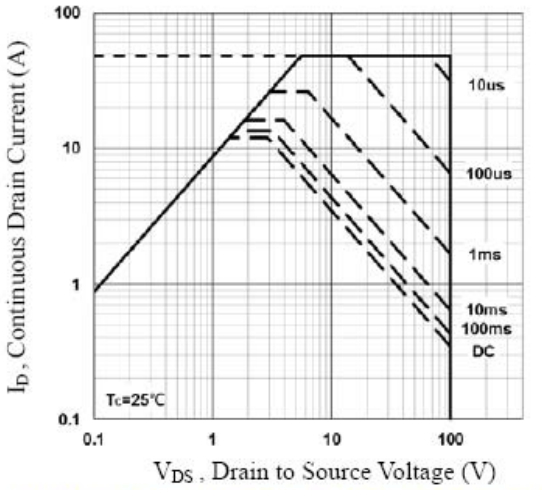
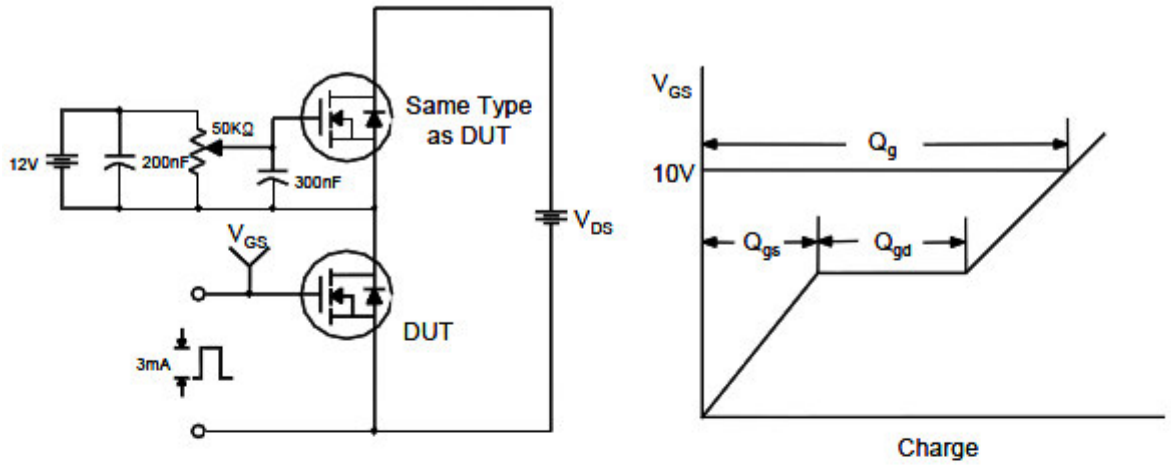


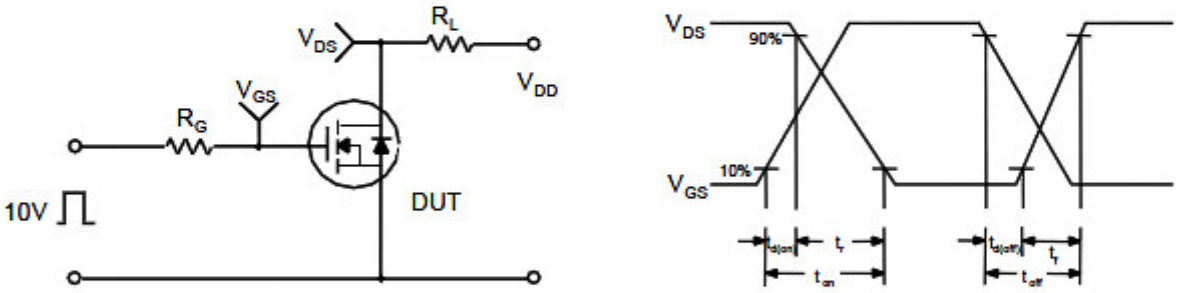
Fig.6 Maximum Safe Operation Area

Typical Performance Characteristics (Continue)

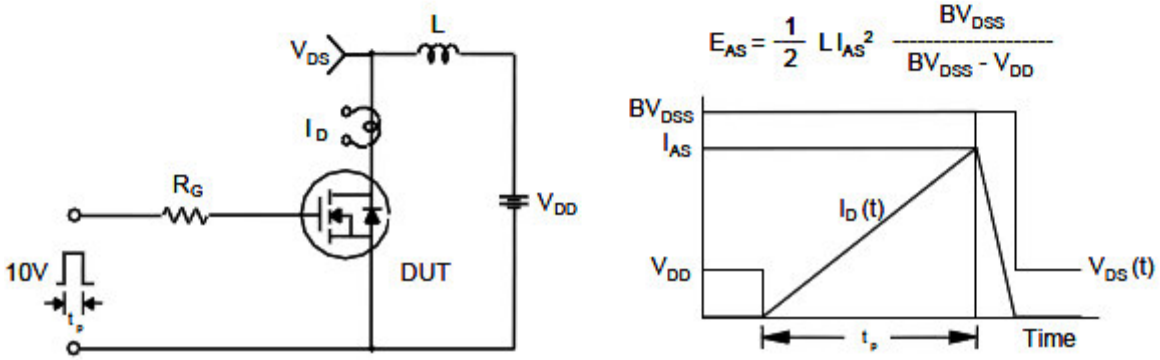
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

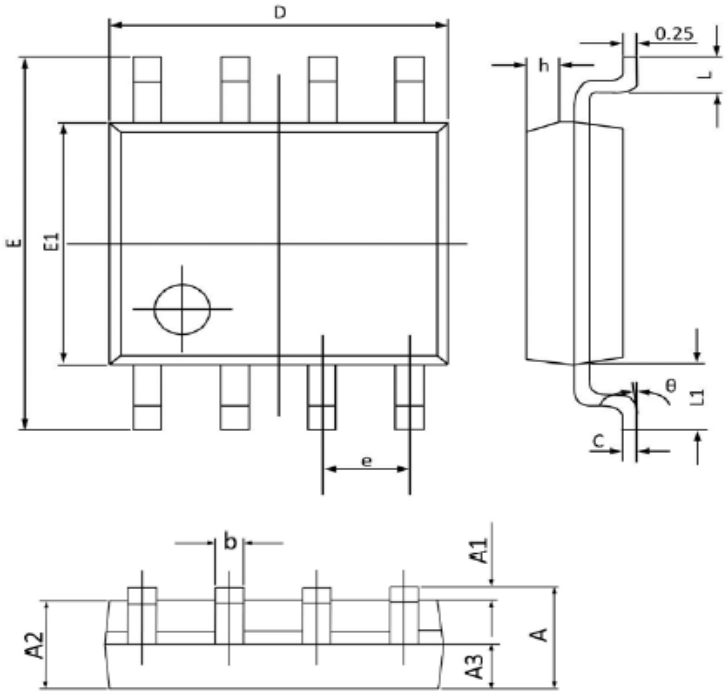


Unclamped Inductive Switching Test Circuit & Waveforms



Package Dimension

SOP-8



Dimensions				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.068
A1	0.100	0.250	0.004	0.009
A2	1.300	1.500	0.052	0.059
A3	0.600	0.700	0.024	0.027
b	0.390	0.480	0.016	0.018
c	0.210	0.260	0.009	0.010
D	4.700	5.100	0.186	0.200
E	5.800	6.200	0.229	0.244
E1	3.700	4.100	0.146	0.161
e	1.270 (BSC)		0.050 (BSC)	
h	0.250	0.500	0.010	0.019
L	0.500	0.800	0.019	0.031
L1	1.050 (BSC)		0.041 (BSC)	
θ	0°	8°	0°	8°

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